

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Vishay/Siliconix SI4459ADY-T1-GE3

For any questions, you can email us directly: sales@integrated-circuit.com



Vishay Siliconix

P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|--------------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^d | Q _g (Typ.) | | |
| - 30 | 0.005 at V _{GS} = - 10 V | - 29 | 61 nC | | |
| - 30 | 0.00775 at V _{GS} = - 4.5 V | - 23 | 01110 | | |

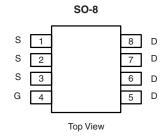
FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Adaptor Switch
- Notebook





Ordering Information: Si4459ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

| Parameter | Symbol | Limit | Unit | |
|---|-----------------------------------|-----------------|------------------------|----|
| Drain-Source Voltage | V _{DS} | - 30 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | - 29 | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | 1 , [| - 23.5 | |
| Continuous Diain Curient (1 _J = 150 °C) | T _A = 25 °C | l _D | - 19.7 ^{a, b} | |
| | T _A = 70 °C | 1 | - 15.6 ^{a, b} | |
| Pulsed Drain Current | I _{DM} | - 70 | Α | |
| Continuos Comos Dunis Diada Comost | T _C = 25 °C | | - 6.5 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | - 2.9 ^{a, b} | |
| Avalanche Current | 1 04 | I _{AS} | - 30 | |
| Single-Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 45 | mJ |
| | T _C = 25 °C | | 7.8 | |
| Martin and Branch Black to all an | T _C = 70 °C | 1 , [| 5 | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 3.5 ^{a, b} | W |
| | T _A = 70 °C | 1 | 2.2 ^{a, b} | |
| Operating Junction and Storage Temperature Rang | T _J , T _{stq} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|--------------|--------------------|---------|---------|--------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 29 | 35 | °C/W | | |
| Maximum Junction-to-Foot | Steady State | R _{th.IF} | 13 | 16 | J C/VV | | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 80 °C/W.
- d. Based on $T_C = 25$ °C.

Document Number: 69979 S11-1813-Rev. B, 12-Sep-11 www.vishay.com



Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SI4459ADY-T1-GE3 - MOSFET P-CH 30V 29A 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Si4459ADY

Vishay Siliconix



| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | | |
|--|-------------------------|--|---|--------|---------|-------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | 1 - 2504 | | - 31 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | | 5.3 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1 | | - 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | | |
| | | V _{DS} = - 30 V, V _{GS} = 0 V | / _{DS} = - 30 V, V _{GS} = 0 V | | - 100 | nA | |
| Zoro Coto Voltago Drain Current | l | V _{DS} = - 20 V, V _{GS} = 0 V | | | - 75 | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 75 °C | | | - 10 | μΑ | |
| | | V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 75 °C | | | - 3 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| | _ | V _{GS} = - 10 V, I _D = - 15 A | | 0.0039 | 0.005 | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 10 A | | 0.0062 | 0.00775 | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 15 A | | 24 | | S | |
| Dynamic ^b | | | | • | • | , | |
| Input Capacitance | C _{iss} | | | 6000 | | | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 860 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 790 | | | |
| Total Cata Charge | 0 | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -20 \text{ A}$ | | 129 | 195 | nC | |
| Total Gate Charge | Qg | | | 61 | 95 | | |
| Gate-Source Charge | Q_{gs} V_{I} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$ | | 16.5 | | | |
| Gate-Drain Charge | Q _{gd} | | | 23.5 | | | |
| Gate Resistance | R _g | f = 1 MHz | 0.6 | 3 | 6 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 16 | 30 | | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 1.5 Ω | | 16 | 30 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 80 | 150 | | |
| Fall Time | t _f | | | 20 | 40 |] | |
| Turn-On Delay Time | t _{d(on)} | | | 75 | 150 | ns | |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$ | | 130 | 260 | 1 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 60 | 120 | | |
| Fall Time | t _f | | | 40 | 80 | | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Continous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 29 | ^ | |
| Pulse Diode Forward Current | I _{SM} | | | | - 70 | Α | |
| Body Diode Voltage | V _{SD} | I _S = - 3 A, V _{GS} = 0 V | | - 0.71 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 67 | 130 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | L = E A dl/dt = 100 A/va T = 05 °C | | 74 | 150 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = -5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | | 22 | | | |
| Reverse Recovery Rise Time | t _b | | | 45 | | ns | |
| lotes: | | | | | | | |

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

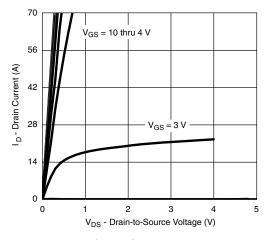
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



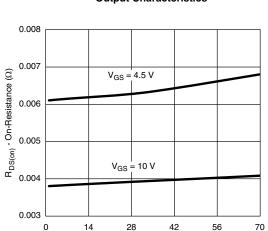


Vishay Siliconix

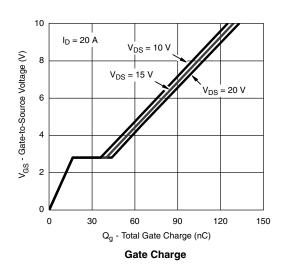
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

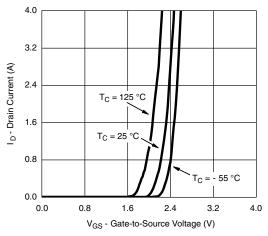


Output Characteristics

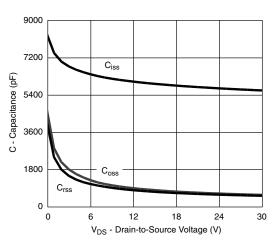


ID - Drain Current (A) On-Resistance vs. Drain Current

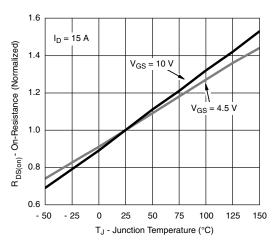




Transfer Characteristics



Capacitance



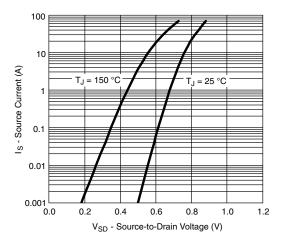
On-Resistance vs. Junction Temperature

Document Number: 69979 S11-1813-Rev. B, 12-Sep-11

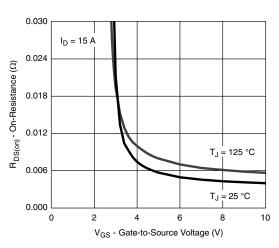


Vishay Siliconix

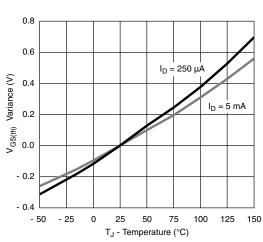
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



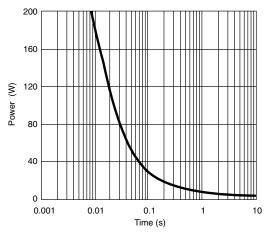
Source-Drain Diode Forward Voltage



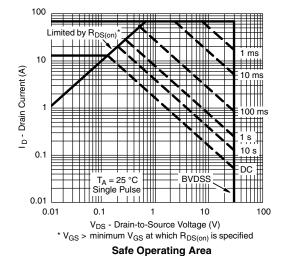
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



www.vishay.com

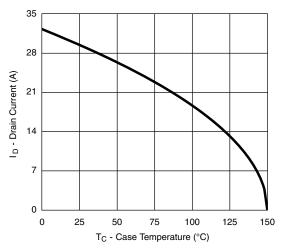
Document Number: 69979 S11-1813-Rev. B, 12-Sep-11



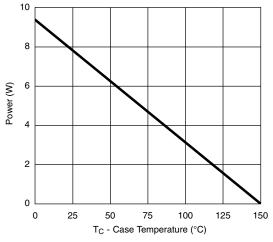


Vishay Siliconix

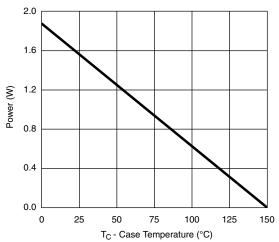
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*



Power, Junction-to-Foot



Power Derating, Junction-to-Ambient

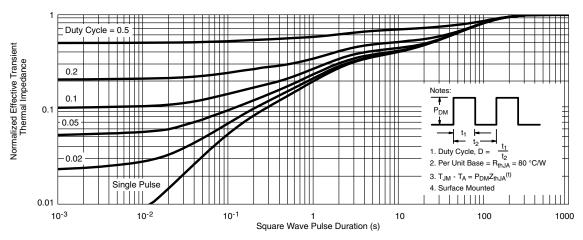
Document Number: 69979 S11-1813-Rev. B, 12-Sep-11

 $^{^{\}star}$ The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

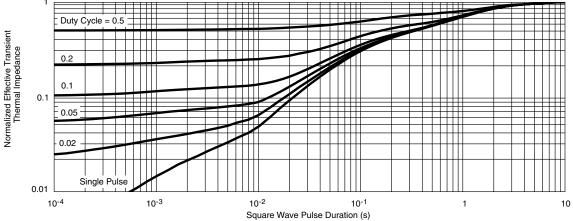


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69979.

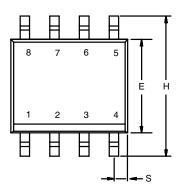


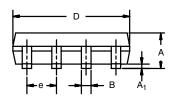


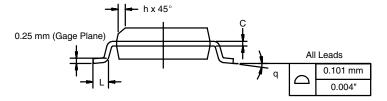
Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







| | MILLIM | IETERS | INC | HES | |
|--------------------------------|--------|--------|-----------|-------|--|
| DIM | Min | Max | Min | Max | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | |
| е | 1.27 | BSC | 0.050 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | |
| q | 0° | 8° | 0° | 8° | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | |
| ECN: C-06527-Rev. I. 11-Sep-06 | | | | | |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06 sww.vishay.com

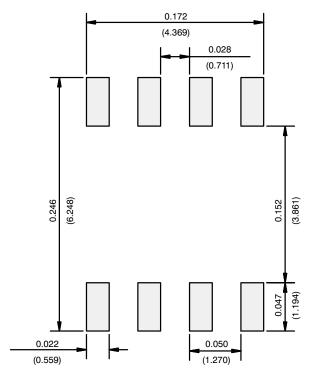


Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOT

www.vishay.com Document Number: 72606
22 Revision: 21-Jan-08



Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SI4459ADY-T1-GE3 - MOSFET P-CH 30V 29A 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



Legal Disclaimer Notice

Vishav

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000